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FORM PTO-1595 (Modified) (Rev. 03-01) OMB No. 0651-0027 (exp.5/31/2002) P08A/REV03 07-21-2005



Docket No.: GIAN-4347

ΕT

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Tab settings → → ▼ 1030450)¢o, ∀			
To the Director of the United States Patent and Trademark Office	ce: Please record the attached original documents or copy thereof.			
Name of conveying party(ies): Jong-Ning Aoh	2. Name and address of receiving party(ies):			
Cheng-Li Chuang	Name: National Chung Cheng University			
	Address: 160 San-Hsing, Min-Hsiung			
Additional names(s) of conveying party(ies)	Chia-Yi 621 Taiwan, R.O.C.			
3. Nature of conveyance:	-			
☑ Assignment ☐ Merger				
☐ Security Agreement ☐ Change of Name	City: State/Prov.:			
☐ Other	Country: ZIP:			
Execution Date: May 4, 2005	Additional name(s) & address(es)			
4. Application number(s) or patent numbers(s):				
If this document is being filed together with a new application	, the execution date of the application is: 5/4/05; 4/14/05			
Patent Application No. Filing date	B. Patent No.(s)			
07/15/2005 HTECKLU1 00000028 11180448 04 FC:8021 40.00 0P				
04 FC:8021				
Additional numbers	☐ Yes ☐ No			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:			
Name: Customer No. 5409	7. Total fee (37 CFR 3.41):\$ 40.00			
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9. Statement and signature. To the best of my knowledge and belief, the foregoing inform of the original document.	ation is true and correct and any attached copy is a true copy			
Lisa A. Molloy	July 13, 2005			
Name of Person Signing	Signature Date			

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ASSIGNMENT

Whereas, We

- (1) Jong-Ning Aoh
- (2) Cheng-Li Chuang

have invented certain improvements in a:

METHOD OF REALIZING THERMOSONIC WIRE BONDING BETWEEN METAL WIRES AND COPPER PADS BY DEPOSITING A THIN FILM TO SURFACE OF SEMICONDUCTOR CHIP WITH COPPER PADS (Title)

And whereas, NATIONAL CHUNG CHENG UNIVERSITY, a university of ________, having a place at 160 San-Hsing, Min-Hsiung, Chia-Yi 621 Taiwan, R.O.C. (hereinafter called _________), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to Assignee, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to Assignee, its successors and assigns; and we hereby agree that Assignee may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Assignee.

(1) Date:	(Aoh, Jong First Name	-Ning Middle	Last Name)	Signature Inventor
May 4, 2005					
(2) Date:	Chuo 9 (Chuand C First Name		Last Name)	Signature Inventor
May 4, 2005					
(3) Date:	(First Name	Middle) Last Name		Signature Inventor

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PATENT REEL: 016779 FRAME: 0905